

Product Description

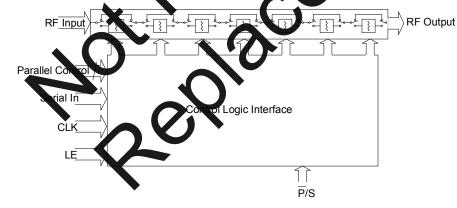
The PE43602 is a HaRP™-enhanced, high linearity, 6-bit RF Digital Step Attenuator (DSA) covering a 31.5 dB attenuation range in 0.5 dB steps. This Peregrine 50Ω RF DSA provides both a serial and parallel CMOS control interface. It maintains high attenuation accuracy over frequency and temperature and exhibits very low insertion loss and low power consumption. Performance does not change with V_{DD} due to on-board regulator. This next generation Peregrine DSA is available in a 4x4 mm 24 lead QFN footprint.

The PE43602 is manufactured on Peregrine's UltraCMOS™ process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of convention CMOS.

Figure 1. Package Photo 24-lead 4x4x0.85 mm QFN Package



Figure 2. Functiona Schematic Diagrar



Product Specification PE43602

50 Ω RF Digital Attenuator 6-bit, 31.5 dB, 9 kHz - 5.0 GHz

Features

- HaRP™-enhanced UltraCMOS™ device
- High Linear bical +58 d
- Voltage
- attendation state @ power-up (PUP)
- IOS Compatible
- to DC blocking capacitors required
- Packaged in a 24-lead 4x4x0.85 mm QFN



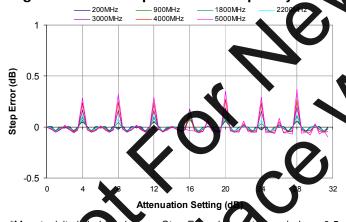
Table 1. Electrical Specifications @ +25 ℃, V_{DD} = 3.3 V or 5.0 V

Parameter	Test Conditions	Frequency	Min	Typical	Max	Units
Frequency Range			9 kHz		5 GHz	
Attenuation Range	0.5 dB Step			0 – 31.5		dB
Insertion Loss		9 kHz ≤ 5 GHz		2.2	2.7	dB
Attenuation Error	0 dB - 31.5 dB Attenuation settings 0 dB - 31.5 dB Attenuation settings 0 dB - 31.5 dB Attenuation settings	9 kHz < 4 GHz 4 GHz ≤ 5 GHz 4 GHz ≤ 5 GHz		Co	±(0.3 + 3)% +0.4 + 5% -0.3 - 3%	dB dB dB
Return Loss		9 kHz - 5 GHz		18		dВ
Relative Phase	All States	9 kHz - 5 GHz		55		dec
P1dB (note 1)	Input	20 MHz - 5 GHz	30	32		dBm
IIP3	Two tones at +18 dBm, 20 MHz spacing	20 MHz - 5 GHz	+,	58		dBm
Typical Spurious Value		1 MHz		-110		dBm
Video Feed Through						mVpp
Switching Time	50% DC CTRL to 10% / 90% RF			650		ns
RF Trise/Tfall	10% / 90% RF	_ (/		400		ns
Settling Time	RF settled to within 0.05 dB of final value RBW = 5 MHz, Averaging ON.			X		μs

Note 1. Please note Maximum Operating Pin (50Ω) of +23dBm as shown in Table 3.

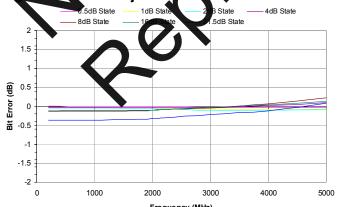
Performance Plots

Figure 3. 0.5dB Step Error vs. Frequency'



*Monotonicity is held so long as Step-Effor does not coss below -0.5

Figure 5. 0.5dB Major State Bit Error



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Figure 4. 1de Attenuation vs. Attenuation State

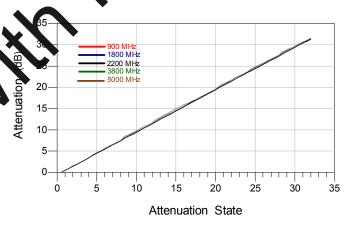
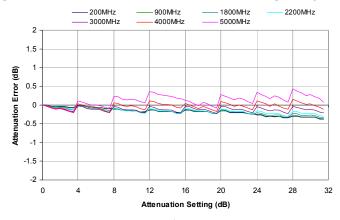


Figure 6. 0.5dB Attenuation Error vs. Frequency



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UltraCMOS™ RFIC Solutions



Figure 7. Insertion Loss vs. Temperature

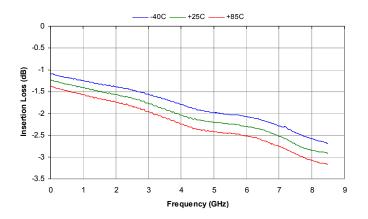


Figure 9. Output Return Loss vs. Attenuation @T = +25C

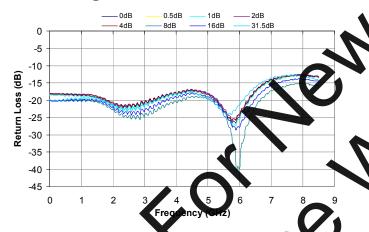


Figure 11. Attenuation Error vs. Te

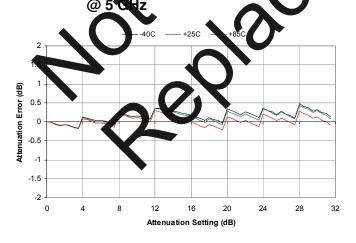
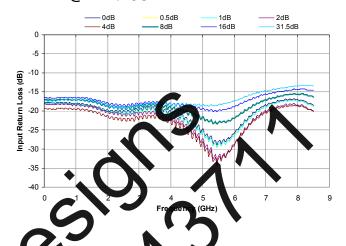


Figure 8. Input Return Loss vs. Attenuation @ T = +25C



s. Frequency

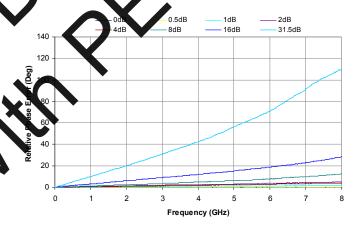


Figure 12. Input IP3 vs. Frequency

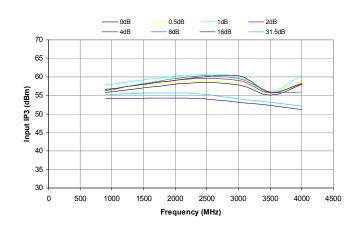




Figure 13. Pin Configuration (Top View)

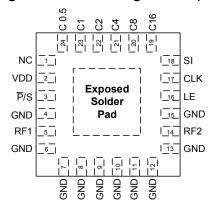


Table 2. Pin Descriptions

Dis No. 1 Dis Nove 1 Description					
Pin No.	Pin Name	Description			
1	GND	Ground			
2	V_{DD}	Power supply pin			
3	P/S	Serial/Parallel mode select			
4	GND	Ground			
5	RF1	RF1 port			
6 - 13	GND	Ground			
14	RF2	RF2 port			
15	GND	Ground			
16	LE	Serial interface Latch Enable input			
17	CLK	Serial interface Clock input			
18	SI	Serial interface Data input			
19	C16 (D6)	Parallel control bit, 10 dB			
20	C8 (D5)	Parallel control bit, 8 dB			
21	C4 (D4)	Parallel contro oit, 4 dB			
22	C2 (D3)	Parallel control it, 2 dB			
23	C1 (D2)	Parallel control bit, 1 dB			
24	C0.5 (D1)	arallel control bit, 0.5 dB			
Paddle	GND	Graund for proper operation			

Note: Ground C0.5, C1, C8, C16 if not in us

Exposed Solder Pad Connection

The expose r pad on the package must be

Moisture Sensitivity I

g for the PE43602 in The Mosture Sensitivity the 24-lead 4x4

Switching Frequency

The PE43602 has a maximum 25 kHz switching rate. Switching rate is defined to be the speed at which the DSA can be toggled across attenuation states.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

Parameter	Min	Тур	Max	Units
V _{DD} Power Supply Voltage	3.0	3.3		V
V _{DD} Power Supply Voltage		5.0	5.5	V
I _{DD} Power Supply Current		70	350	μΑ
Digital Input High	2.6		5.5	V
P _{IN} Input power (50Ω): 9 kHz ≤ 20 MH 20 MHz ≤ 5 GHz	:5		Fig.114 +23	dBm dBm
T _{OP} Operating temperature singe	-40	25	85	°C
Digital Input Low	0		1	V
Digital Input Leukage		1	15	μΑ

Table 3. Operating Ranges

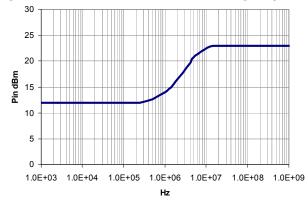
Table

Symbol	Parameter/Conditions	Min	Max	Units
V _{DD}	ower supply oltage	-0.3	6.0	V
V_1	Voltage or any Dinita input	-0.3	5.8	V
Tat	Storage temperature range	-65	150	℃
P _{IN}	Insur power (5.0) 9 kHz ≤ 20 MHz 20 MHz ≤ 5 GHz		Fig. 14 +23	dBm dBm
V _{ESD}	ESD voltage (HBM) ¹ ESD voltage (Machine Model)		500 100	V V

nan Body Model (HBM, MIL STD 883 Method 3015.7)

eeding absolute maximum ratings may cause ermanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

Figure 14. Maximum Power Handling Capability



Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS™ device, observe the same precautions that you would use with other ESDsensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.



D0

(LSB)

L

L

Attenuation Setting

RF1-RF2

Reference I.L.

0.5 dB

1 dB

8 dB 16 dB 31.5 dB

Table 8. Serial Attenuation Word Truth Table

D2

L

D1

Attenuation Word

D3

L

L

D4

L

L

D7

L

D6

L

L

D5

L

L

L

Table 5. Control Voltage

State	Bias Condition				
Low	0 to +1.0 Vdc at 2 μA (typ)				
High	+2.6 to +5 Vdc at 10 μA (typ)				

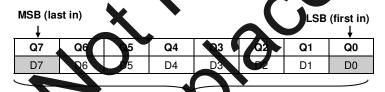
Table 6. Latch and Clock Specifications

Latch Enable	Shift Clock	Function
X	↑	Shift Register Clocked
1	X	Contents of shift register transferred to attenuator core

Table 7. Parallel Truth Table

Parallel Control Setting						Attenuation
D6	D5	D4	D3	D2	D1	Setting RF1-RF2
L	L	L	L	L	L	Reference I.L.
L	L	L	L	L	Н	0.5 dB
L	L	L	L	Н	L	1 dB
L	L	L	Н	L	L	2 dB
L	L	Н	L	L	L	4 NB
L	Н	L	L	L	L	8 dB
Н	L	L	L	L	L	16 dB
Н	Н	Н	Н	Н	H	31.5 dB

Table 9. Serial Rec



Bits must be set to logic low

Attenuation V rived directly from the attenuation value. For example, to program the 12.5 dB state:

Attenuation Word: Multiply by 4 and convert to binary \rightarrow 4 * 12.5 dB \rightarrow 50 \rightarrow 00110010

Serial Input: 00110010



Programming Options

Parallel/Serial Selection

Either a parallel or serial interface can be used to control the PE43602. The \overline{P}/S bit provides this selection, with $\overline{P}/S=LOW$ selecting the parallel interface and $\overline{P}/S=HIGH$ selecting the serial interface.

Parallel Mode Interface

The parallel interface consists of six CMOScompatible control lines that select the desired attenuation state, as shown in Table 7.

The parallel interface timing requirements are defined by Fig. 16 (Parallel Interface Timing Diagram). Table 11 (Parallel Interface AC Characteristics), and switching speed (*Table 1*).

For *latched*-parallel programming the Latch Enable (LE) should be held LOW while changing attenuation state control values, then pulse LE HIGH to LOW (per Fig. 16) to latch new attenuation state into device.

For *direct* parallel programming, the Latch En (LE) line should be pulled HIGH. Changing attenuation state control values will con state to new attenuation. Direct Mode ideal for manual control of the device (using hardwre, switches, or jumpers).

Serial Interface

The serial interface serial-in, paralle shift register buffered a transparent later bits make up the Attenuation Word that controls the DSA. Fig. 15 illustrates a example time programming a

ng three CMOS-The serial interface is control con patible signals: Serial-Clock (CLK), and Latch Enable (LE). The K inputs allow data to be serially shift register. Serial data is clocke

The shift register must be loaded while LE is held LOW to prevent the attenuator value from changing as data is entered. The LE input should then be toggled HIGH and brought LOW again, latching the new data into the DSA. Attenuation Word truth table is listed in *Table 8*. A programming example of the serial register is illustrated in Table 9. The serial timing diagram is illustrated in Fig. 15. It is required that all parallel pins be grounded when the DSA is used in serial mode.

Power-up Control Sett

The PE4602 will initialize to the attenuation setting (3 5 dB) on p er-up for both rallel modes of operation the serial and and will remain until the user latches in In direct-parallel mode. any state within the 31.5 arallel control pins prior pre-setting he s mode there is a 400-us delay een the tink the SA is powered-up to the time set. During this power-up delay, the device atten the maximum attenuation uates setting (375.48) before defaulting to the user defined state. If the control pins are left floating in this made during power-up, the device will default to niningum attenuation setting (insertion loss

mamic operation between serial and parallel programming modes is possible.

If the DSA powers up in serial mode ($\overline{P}/S = HIGH$), all the parallel control inputs DI[6:1] must be set to logic low. Prior to toggling to parallel mode, the DSA must be programmed serially to ensure D[7] is set to logic low.

If the DSA powers up in either latched or directparallel mode, all parallel pins DI[6:1] must be set to logic low prior to toggling to serial mode (\overline{P}/S = HIGH), and held low until the DSA has been programmed serially to ensure bit D[7] is set to logic low.

The sequencing is only required once on powerup. Once completed, the DSA may be toggled between serial and parallel programming modes at will.



Figure 15. Serial Timing Diagram

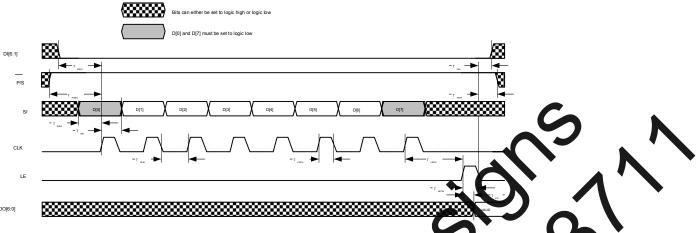


Figure 16. Latched-Parallel/Direct-Parallel Timing Diagram

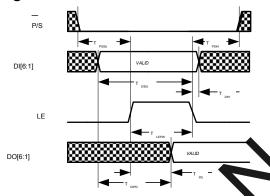


Table 10. Serial Interface AC **Characteristics**

 $V_{DD} = 3.3 \text{ or } 5.0 \text{ V}, -40 \,^{\circ}\text{ C} \leq T_{A}$ ess otherwise spec

Symbol	Parameter	Min.	Max.	Unit
F _{CLK}	Serial clock frequency	-	10	MHz
T_{CLKH}	Serial clock HIGH time	30		18
T_{CLKL}	Serial clock LOW time	30	1	ns
T _{LESU}	Last serial check rising edge setur time to Lach Enable rising edge),	ns
TLEPW	atch Enable minimum pulse wick	8	1	ns
Tsist	Serial data setup time	10	-	ns
T _{SIH}	Serial data hold time	10	1	ns
T_{DISU}	Parallel data setup time	100	-	ns
T _{DIH}	Parallel data hold time	100	-	ns
T _{ASU}	Address setup time	100	-	ns
T_AH	Address hold time	100	-	ns
T _{PSSU}	Parallel/Serial setup time	100	-	ns
T _{PSH}	Parallel/Serial hold time	100	-	ns
T_{PD}	Digital register delay (internal)	-	10	ns

Table 11. Parallel and Direct Interface AC **Characteristics**

 V_{DD} = 3.3 or 5.0 V, -40 $^{\circ}$ C < T_{A} < 85 $^{\circ}$ C, unless otherwise specified

Symbol	Parameter	Min	Max	Unit
T_{LEPW}	Latch Enable minimum pulse width	30	-	ns
T _{DISU}	Parallel data setup time	100	-	ns
T _{DIH}	Parallel data hold time	100	-	ns
T _{PSSU}	Parallel/Serial setup time	100	-	ns
T _{PSIH}	Parallel/Serial hold time	100	-	ns
T _{PD}	Digital register delay (internal)	-	10	ns
T _{DIPD}	Digital register delay (internal, direct mode only)	-	5	ns



Evaluation Kit

The Digital Attenuator Evaluation Kit board was designed to ease customer evaluation of the PE43602 Digital Step Attenuator.

Direct-Parallel Programming Procedure
For automated direct-parallel programming, connect the test harness provided with the EVK from the parallel port of the PC to the J1 & Serial header pin and set the D0-D6 SP3T switches to the 'MIDDLE' toggle position. Position the Parallel/Serial (P/S) select switch to the Parallel (or left) position. The evaluation software is written to operate the DSA in either Parallel or Serial-Addressable Mode. Ensure that the software is set to program in Direct-Parallel mode. Using the software, enable or disable each setting to the desired attenuation state. The software automatically programs the DSA each time an attenuation state is enabled or disabled.

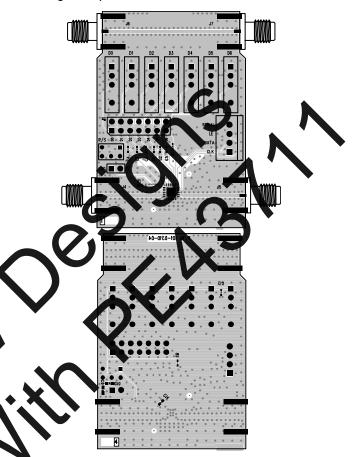
For manual direct-parallel programming, disconnect the test harness provided with t from the J1 and Serial header pins. Position Parallel/Serial (\overline{P}/S) select switch to the (or left) position. The LE pin on the Se must be tied to V_{DD}. Switches D0-D6 re SP3T switches which enable the user to manually any input D0-D program the parallel bits. When is toggled 'UP', logic high is presented to the parallel input. When toggled 'DDWN', logic low is presented to the parallel input. Setting D0 the 'MIDDLE' toggle position presents which forces an on-chip logic low. Table 9 the parallel progr mming truth tab illustrates the parallel program diagram

Latched-Parallel Programming Procedure
For automated latched parallel programming, the procedure is identically the direct-parallel method. The user only must ensure that Latched-Parallel is selected in the software.

For manual latched-parallel programming, the procedure is identical to direct-parallel except now the LE pin on the Serial header must be logic low

Figure 17. Evaluation Board Layout

Peregrine Specification 101-0310



Note: Reference Figure 18 for Evaluation Board Schematic

as the parallel bits are applied. The user must then pulse LE from 0V to V_{DD} and back to 0V to latch the programming word into the DSA. LE must be logic low prior to programming the next word.

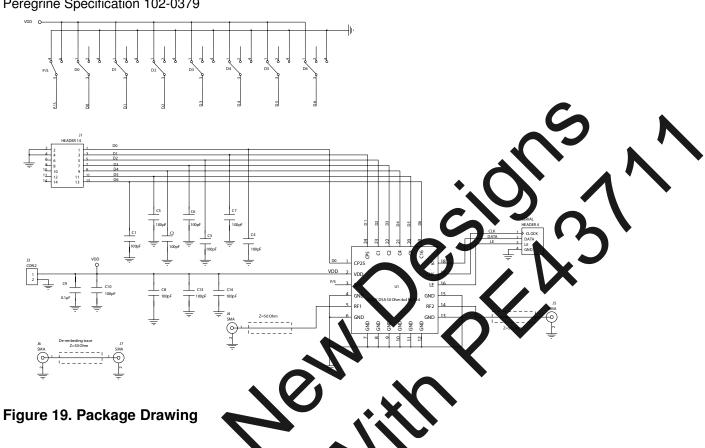
Serial Programming Procedure

Position the Parallel/Serial (P/S) select switch to the Serial (or right) position. The evaluation software is written to operate the DSA in either Parallel or Serial Mode. Ensure that the software is set to program in Serial mode. Using the software, enable or disable each setting to the desired attenuation state. The software automatically programs the DSA each time an attenuation state is enabled or disabled.



Figure 18. Evaluation Board Schematic

Peregrine Specification 102-0379



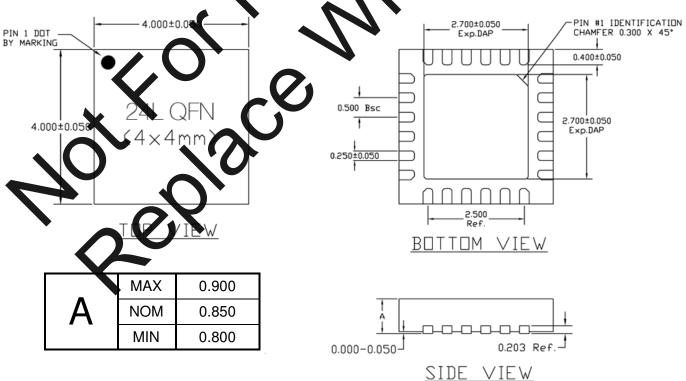


Figure 20. Tape and Reel Drawing

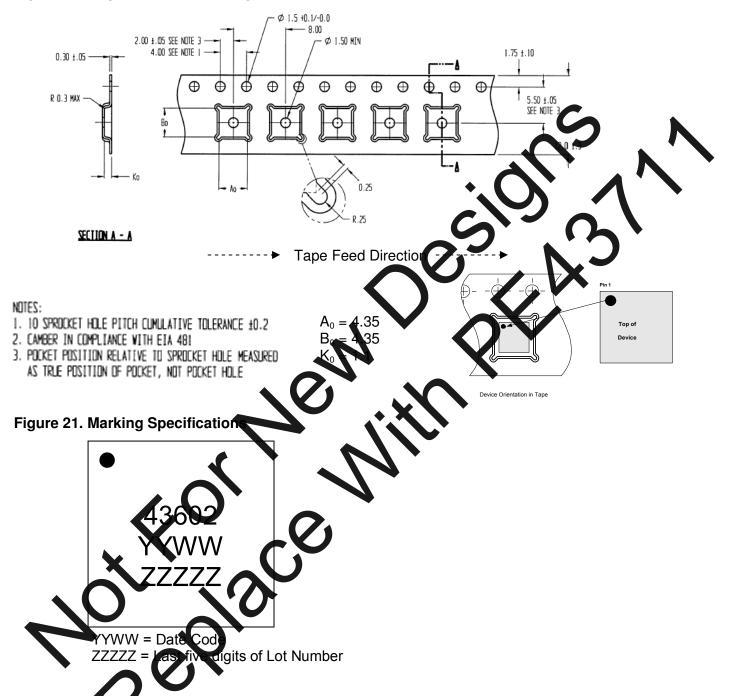


Table 12. Ordering Information

Order Code	Part Marking	Description	Package	Shipping Method
PE43602 MLI	43602	PE43602G-24QFN 4x4mm-75A	Green 24-lead 4x4mm QFN	Bulk or tape cut from reel
PE43602 MLI-Z	43602	PE43602G-24QFN 4x4mm-3000C	Green 24-lead 4x4mm QFN	3000 units / T&R
EK43602-01	PE43602 -EK	PE43602-24QFN 4x4mm-EK	Evaluation Kit	1 / Box



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t of representatives in your area, please refer to our site at: www.psemi.com

Data Sheet Identificati

Advance Information

The product is in a formative or design stage sheet contains met specification development Spec ications and fe any mann notice.

Preliminary Specification

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Product Specification

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